Special Issue

Advanced Welding Processes, Additive Manufacturing and Numerical Models

Message from the Guest Editor

Welding and additive manufacturing are key technologies in the modern manufacturing industry that have increasing needs relating to high-quality products. high-volume deposition, and high-temperature application. This Special Issue aims to highlight the latest progress on the welding process and additive manufacturing development towards the fabrication of new structures, the innovation of functional materials. and the optimization of manufacturing processes. Fulllength research articles on welding technology development, weld consumables, powder material. additive manufacturing process, numerical modeling, and process monitoring and control, among other things, are welcome. The world's leading experts in the field of welding and additive manufacturing will be invited to submit their findings. Accepted papers will be open access for the whole research community in order to increase the visibility of their innovative research findinas.

Guest Editor

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Deadline for manuscript submissions

closed (1 October 2024)



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About the Journal

Message from the Editor-in-Chief

Journal of Manufacturing and Materials Processing (JMMP)(ISSN 2504-4494) is a new MDPI peer-reviewed, open access venue with a focus on the scientific fundamentals and engineering methodologies of manufacturing and materials processing. We offer an online platform facilitating effective exchange of innovative scientific and engineering ideas and the dissemination of recent, original, and significant research and developmental findings. On behalf of the Editorial Board, I extend an invitation to our scientific and engineering colleagues to contribute high-quality, innovative, and ground-breaking research articles to .IMMP.

Editor-in-Chief

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